TOSHIBA Field Effect Transistor Silicon N Channel MOS Type (π -MOSVII)

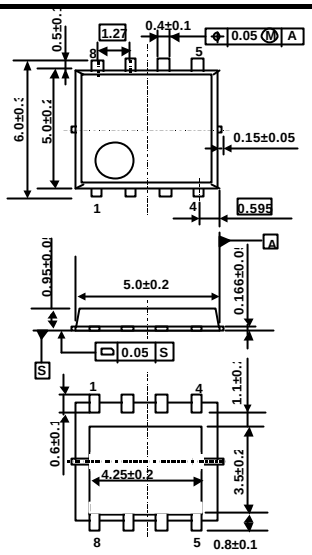
TPCA8007-H

Switching Regulator Applications

Motor Drive Applications

- Small footprint due to small and thin package
- High speed switching
- Low drain-source ON resistance
  : $R_{DS\ (ON)}$ = 30 mΩ (typ.) (V_G=10V, I_D=10A)
- High forward transfer admittance: $|Y_{fs}|$ = 19 S (typ.)
- Low leakage current: I_{DSS} = 100 μA (max) (V_{DS} = 100 V)
- Enhancement mode: V_{th} = 3.0 to 5.0 V (V_{DS} = 10 V, I_D = 1 mA)

Unit: mm



1,2,3 : SOURCE 4 : GATE
5,6,7,8 : DRAIN

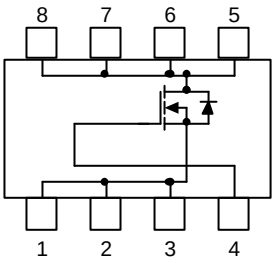
JEDEC	?
JEITA	?
TOSHIBA	2-5Q1A

Weight: 0.080 g (typ.)

Maximum Ratings (Ta = 25°C)

Characteristics		Symbol	Rating	Unit
Drain-source voltage		V_{DSS}	100	V
Drain-gate voltage (R_{GS} = 20 kΩ)		V_{DGR}	100	V
Gate-source voltage		V_{GSS}	±20	V
Drain current	DC (Note 1)	I_D	20	A
	Pulsed (Note 1)	I_{DP}	40	
Drain power dissipation (Tc=25°C)		P_D	45	W
Drain power dissipation (t = 10 s) (Note 2a)		P_D	2.8	W
Drain power dissipation (t = 10 s) (Note 2b)		P_D	1.6	W
Single pulse avalanche energy (Note 3)		E_{AS}	351	mJ
Avalanche current		I_{AR}	20	A
Repetitive avalanche energy (Note 2a) (Note 4)		E_{AR}	4.5	mJ
Channel temperature		T_{ch}	150	°C
Storage temperature range		T_{stg}	−55 to 150	°C

Circuit Configuration



Note: For (Note 1), (Note 2), (Note 3), (Note 4), please refer to the next page.

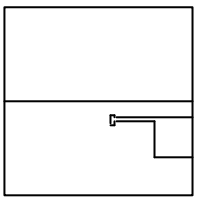
This transistor is an electrostatic sensitive device. Please handle with caution.

Thermal Characteristics

Characteristics	Symbol	Max	Unit
Thermal resistance, channel to case (Tc=25°C)	$R_{th\ (ch\text{-}c)}$	2.78	°C/W
Thermal resistance, channel to ambient (t = 10 s) (Note 2a)	$R_{th\ (ch\text{-}a)}$	44.6	°C/W
Thermal resistance, channel to ambient (t = 10 s) (Note 2b)	$R_{th\ (ch\text{-}a)}$	78.1	°C/W

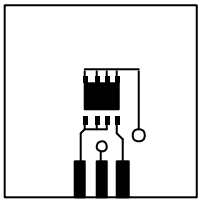
Note 1: Please use devices on condition that the channel temperature is below 150°C.

Note 2: (a) Device mounted on a glass-epoxy board (a) (b) Device mounted on a glass-epoxy board (b)



FR-4
25.4 × 25.4 × 0.8
(Unit: mm)

(a)



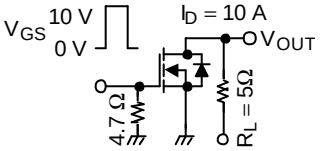
FR-4
25.4 × 25.4 × 0.8
(Unit: mm)

(b)

Note 3: V_{DD} = 50 V, T_{ch} = 25°C (initial), L = 1.0 mH, R_G = 25 Ω, I_{AR} = 20 A

Note 4: Repetitive rating: pulse width limited by max channel temperature

Electrical Characteristics (Ta = 25°C)

Characteristics		Symbol	Test Condition	Min	Typ.	Max	Unit
Gate leakage current		I_{GSS}	V_{GS} = ±20 V, V_{DS} = 0 V	—	—	±100	nA
Drain cut-OFF current		I_{DSS}	V_{DS} = 100 V, V_{GS} = 0 V	—	—	100	μA
Drain-source breakdown voltage		$V_{(BR)\ DSS}$	I_D = 10 mA, V_{GS} = 0 V	100	—	—	V
Gate threshold voltage		V_{th}	V_{DS} = 10 V, I_D = 1 mA	3.0	—	5.0	V
Drain-source ON resistance		$R_{DS\ (ON)}$	V_{GS} = 10 V, I_D = 10 A	—	30	47	mΩ
Forward transfer admittance		$\|Y_{fs}\|$	V_{DS} = 10 V, I_D = 10 A	9.5	19	—	S
Input capacitance		C_{iss}	V_{DS} = 10 V, V_{GS} = 0 V, f = 1 MHz	—	1000	—	pF
Reverse transfer capacitance		C_{rss}		—	21	—	
Output capacitance		C_{oss}		—	500	—	
Switching time	Rise time	t_r	 Duty ≤ 1%, t_w = 10 μs	—	(2)	—	ns
	Turn-ON time	t_{on}		—	(13)	—	
	Fall time	t_f		—	3	—	
	Turn-OFF time	t_{off}		—	13	—	
Total gate charge (gate-source plus gate-drain)		Q_g	V_{DD} ≃ 80 V, V_{GS} = 10 V, I_D = 20 A	—	15	—	nC
Gate-source charge 1		Q_{gs1}		—	7.2	—	
Gate-drain (“miller”) charge		Q_{gd}		—	5.0	—	
Gate switch charge		Q_{SW}		—	8.5	—	

Source-Drain Ratings and Characteristics (Ta = 25°C)

Characteristics		Symbol	Test Condition	Min	Typ.	Max	Unit
Drain reverse current	Pulse (tw=1ms)	I_{DRP}	—	—	—	40	A
Forward voltage (diode)		V_{DSF}	I_{DR} = 20 A, V_{GS} = 0 V	—	—	–1.7	V

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